

MiTAC International Corporation

EMC Notice in DVT Phase

for

Project/ Model Name : BE7977

Date	PCB Rev.	Prepared by	Reviewed by
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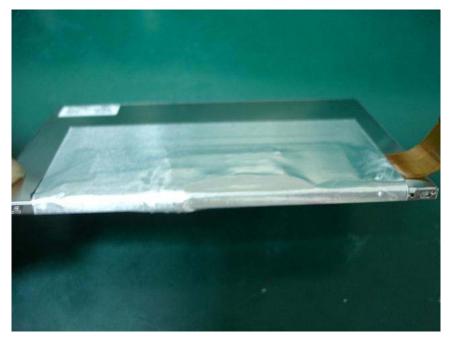
Part 1: EMI E/E solution Main Board: Page07: Change LCR22 to bead 120Z/100M Page19: Change CRV12, CRV19 to CAP 100p Page11: Change OVT4, OTV5 to CAP 33p Daughter Board: Page01: Change CRR14, CRR15 to bead 600Z/100M R01: DAUGHTER BOARD: CRR 14 CRR 15 change to RES 22 ohm Main BOARD:CRR25,CRR26,CRR37,CRR38 change to BEAD 600Z/100m CRR27 change to RES 0 ohm OTL3 change to BEAD 300OHM/100MHZ,25%,-25%,1206(3216) OVT4, OTV5 change to CAP 33p CRC11 change to CAP 0.1u

Part 2 : ME/solution

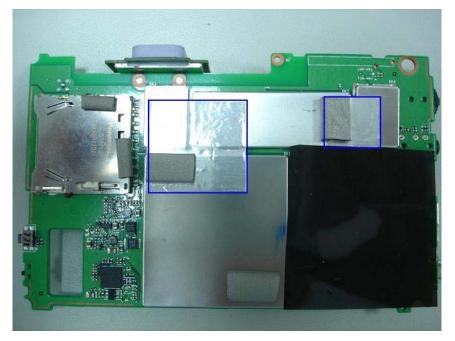
1. Add a mylar L66*W32*0.08T on the LCD FPC P/N: 346164700100



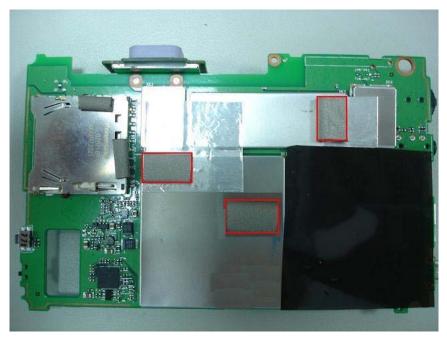
2. Add a AL-foil L85*W49.2*0.085T on the LCD, cover the LCD FPC P/N: 343164700100



3. Add a AL-foil L42*W30*0.085T on the CPU.GPS shielding P/N: 343146800107 Add a AL-foil L15*W10*0.085T on the GPS and BT shielding P/N: 346161900400



4. Add 3 gaskets L10*W8*3. 5T on the main board shielding. PN:



5. Add 1 gasket L5*W5*7T on the main board.



6.Add a GPS antenna isolated cover for GPS ESD. PN :



7.Expose this 2 place at LED board, and add 2 conductive cloth,15mmX20mm, connect LED board to LCD shielding





8. Add 2 gasket at Daughter Board. L5*W8*0.5T



Part 3 : RF solution

Add 2 gaskets on SD slot shielding. Fro RP performance.

